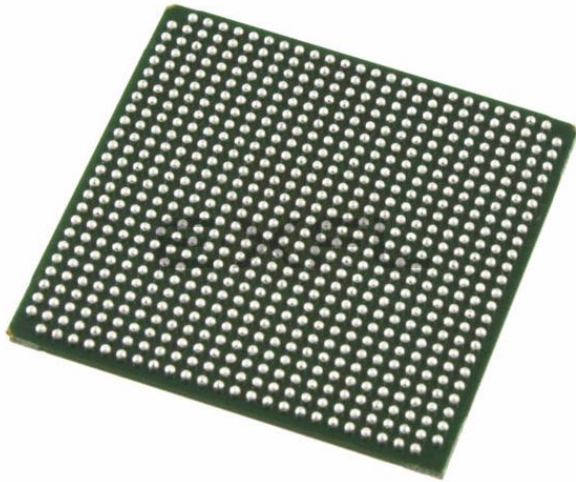




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Active
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	450
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35se-6fn672c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

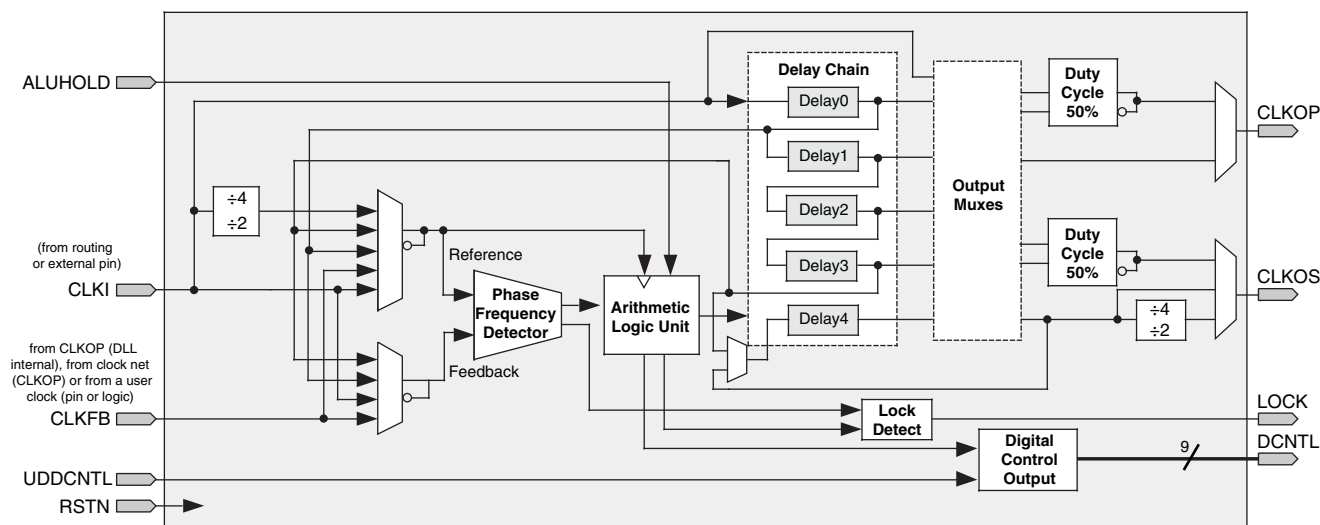
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)



- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

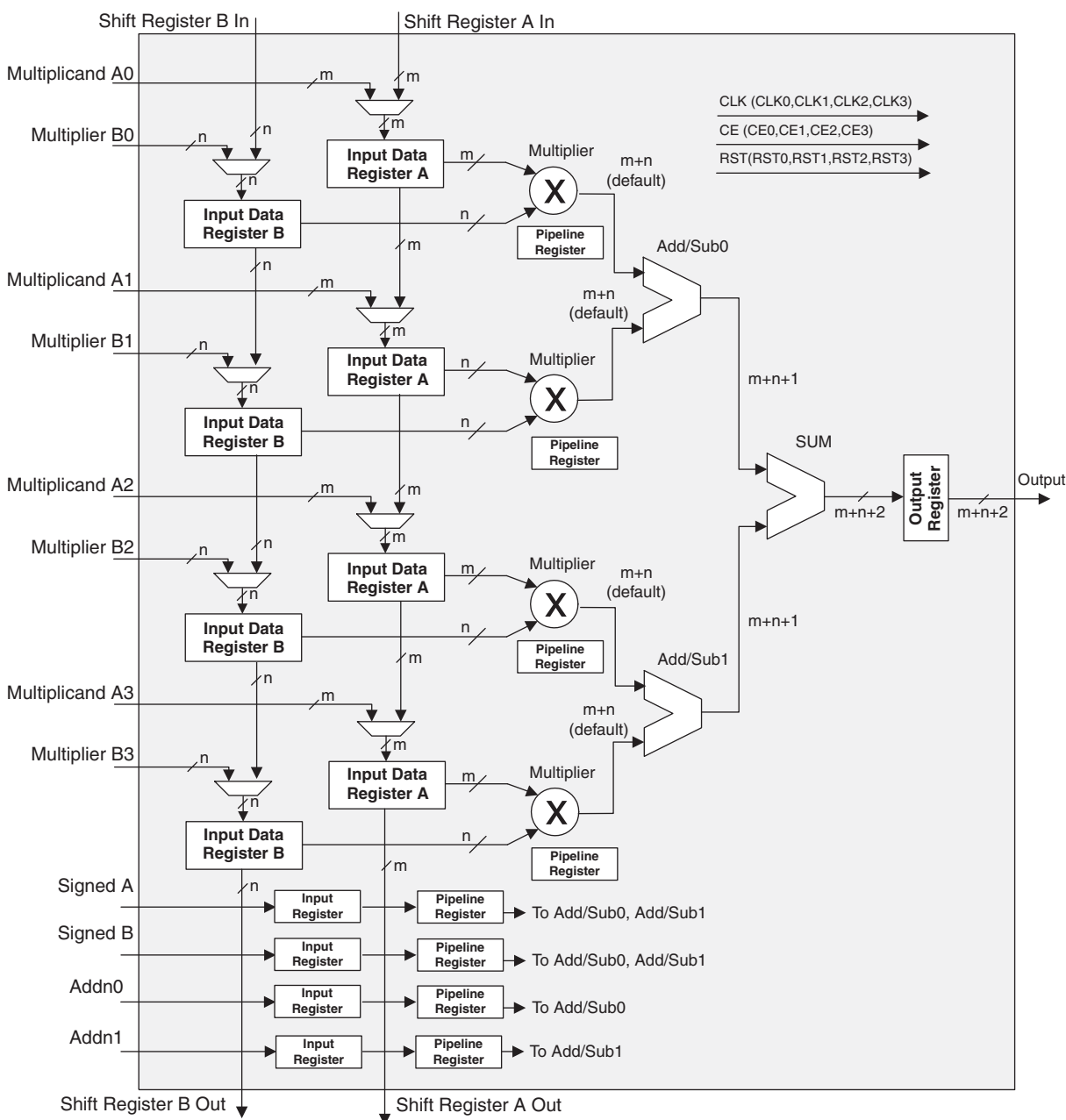
Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

MULTADDSUBSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-26 shows the MULTADDSUBSUM sysDSP element.

Figure 2-26. MULTADDSUBSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3)

IPexpress™

The user can access the sysDSP block via the IPexpress tool, which provides the option to configure each DSP module (or group of modules) or by direct HDL instantiation. In addition, Lattice has partnered with The Math-Works® to support instantiation in the Simulink® tool, a graphical simulation environment. Simulink works with Diamond to dramatically shorten the DSP design cycle in Lattice FPGAs.

Optimized DSP Functions

Lattice provides a library of optimized DSP IP functions. Some of the IP cores planned for the LatticeECP2/M DSP include the Bit Correlator, Fast Fourier Transform, Finite Impulse Response (FIR) Filter, Reed-Solomon Encoder/Decoder, Turbo Encoder/Decoder and Convolutional Encoder/Decoder. Please contact Lattice to obtain the latest list of available DSP IP cores.

Resources Available in the LatticeECP2/M Family

Table 2-9 shows the maximum number of multipliers for each member of the LatticeECP2/M family. Table 2-10 shows the maximum available EBR RAM Blocks in each LatticeECP2/M device. EBR blocks, together with Distributed RAM can be used to store variables locally for fast DSP operations.

Table 2-9. Maximum Number of DSP Blocks in the LatticeECP2/M Family

Device	DSP Block	9x9 Multiplier	18x18 Multiplier	36x36 Multiplier
ECP2-6	3	24	12	3
ECP2-12	6	48	24	6
ECP2-20	7	56	28	7
ECP2-35	8	64	32	8
ECP2-50	18	144	72	18
ECP2-70	22	176	88	22
ECP2M20	6	48	24	6
ECP2M35	8	64	32	8
ECP2M50	22	176	88	22
ECP2M70	24	192	96	24
ECP2M100	42	336	168	42

Table 2-10. Embedded SRAM in the LatticeECP2/M Family

Device	EBR SRAM Block	Total EBR SRAM (Kbits)
ECP2-6	3	55
ECP2-12	12	221
ECP2-20	15	277
ECP2-35	18	332
ECP2-50	21	387
ECP2-70	60	1106
ECP2M20	66	1217
ECP2M35	114	2101
ECP2M50	225	4147
ECP2M70	246	4534
ECP2M100	288	5308

O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

Input Standard	V _{REF} (Nom.)	V _{CCIO} ¹ (Nom.)
Single Ended Interfaces		
LVTTL	—	—
LVC MOS33	—	—
LVC MOS25	—	—
LVC MOS18	—	1.8
LVC MOS15	—	1.5
LVC MOS12	—	—
PCI 33	—	3.3
HSTL18 Class I, II	0.9	—
HSTL15 Class I	0.75	—
SSTL3 Class I, II	1.5	—
SSTL2 Class I, II	1.25	—
SSTL18 Class I, II	0.9	—
Differential Interfaces		
Differential SSTL18 Class I, II	—	—
Differential SSTL2 Class I, II	—	—
Differential SSTL3 Class I, II	—	—
Differential HSTL15 Class I	—	—
Differential HSTL18 Class I, II	—	—
LVDS, MLVDS, LVPECL, BLVDS, RSDS	—	—

¹ When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{H_DELE}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IOE}	Clock Frequency of I/O and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Primary Clock with PLL)¹									
t _{COPLL} ¹⁰	Clock to Output - PIO Output Register	LFE2-6	—	2.30	—	2.60	—	2.80	ns
		LFE2-12	—	2.30	—	2.60	—	2.80	ns
		LFE2-20	—	2.30	—	2.60	—	2.80	ns
		LFE2-35	—	2.30	—	2.60	—	2.80	ns
		LFE2-50	—	2.30	—	2.60	—	2.80	ns
		LFE2-70	—	2.30	—	2.60	—	2.80	ns
		LFE2M20	—	2.30	—	2.60	—	2.80	ns
		LFE2M35	—	2.30	—	2.60	—	2.80	ns
		LFE2M50	—	2.60	—	2.90	—	3.10	ns
		LFE2M70	—	2.60	—	2.90	—	3.10	ns
		LFE2M100	—	2.70	—	3.00	—	3.20	ns
t _{SUPLL}	Clock to Data Setup - PIO Input Register	LFE2-6	0.70	—	0.80	—	0.90	—	ns
		LFE2-12	0.70	—	0.80	—	0.90	—	ns
		LFE2-20	0.70	—	0.80	—	0.90	—	ns
		LFE2-35	0.70	—	0.80	—	0.90	—	ns
		LFE2-50	0.70	—	0.80	—	0.90	—	ns
		LFE2-70	0.70	—	0.80	—	0.90	—	ns
		LFE2M20	0.70	—	0.80	—	0.90	—	ns
		LFE2M35	0.70	—	0.80	—	0.90	—	ns
		LFE2M50	0.70	—	0.80	—	0.90	—	ns
		LFE2M70	0.70	—	0.80	—	0.90	—	ns
		LFE2M100	0.80	—	0.90	—	1.00	—	ns

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	1	0	1	3
	Bank3	0	1	0	1	2
	Bank4	2	4	2	4	3
	Bank5	1	2	1	2	3
	Bank6	0	3	0	1	2
	Bank7	1	2	1	2	3
	Bank8	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	0	0	0	0
	Bank3	0	0	0	0	0
	Bank4	32	62	32	62	50
	Bank5	20	28	20	28	60
	Bank6	16	40	16	39	52
	Bank7	28	40	28	40	60
	Bank8	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	NC	5			PB16B	5	BDQ15	C
47	GND	-			GND	-		
48	VCC				VCC	-		
49	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
50	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
51	GND	-			GND	-		
52	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
53	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
54	VCC	-			VCC	-		
55	PB14A	4	BDQ15	T	PB34A	4	BDQ33	T
56	PB14B	4	BDQ15	C	PB34B	4	BDQ33	C
57	PB16A	4	BDQ15	T	PB40A	4	BDQ42	T
58	PB16B	4	BDQ15	C	PB40B	4	BDQ42	C
59	PB18A	4	BDQ15	T	PB44A	4	BDQ42	T
60	PB18B	4	BDQ15	C	PB44B	4	BDQ42	C
61	GND	-			GND	-		
62	PB20A	4	BDQ24	T	PB48A	4	BDQ51	T
63	PB20B	4	BDQ24	C	PB48B	4	BDQ51	C
64	VCCIO4	4			VCCIO4	4		
65	PB22A	4	BDQ24	T	PB50A	4	BDQ51	T
66	PB22B	4	BDQ24	C	PB50B	4	BDQ51	C
67	PB24A	4	BDQS24	T	PB52A	4	BDQ51	T
68	PB24B	4	BDQ24	C	PB52B	4	BDQ51	C
69	PB26A	4	BDQ24	T	PB54A	4	BDQ51	T
70	PB26B	4	BDQ24	C	PB54B	4	BDQ51	C
71	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
72	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
73	CFG1	8			CFG1	8		
74	CFG2	8			CFG2	8		
75	PROGRAMN	8			PROGRAMN	8		
76	INITN	8			INITN	8		
77	CFG0	8			CFG0	8		
78	CCLK	8			CCLK	8		
79	DONE	8			DONE	8		
80	PR29A	8	D0/SPIFASTN		PR29A	8	D0/SPIFASTN	
81	GND	-			GND	-		
82	PR26A	8	D6		PR26A	8	D6	
83	VCC	-			VCC	-		
84	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
85	VCCIO8	8			VCCIO8	8		
86	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
87	PR24B	8	DOOUT/CSON	C	PR24B	8	DOOUT/CSON	C
88	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
89	VCCIO3	3			VCCIO3	3		
90	VCCAUX	-			VCCAUX	-		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K28	PR25A	2	RDQ29	T (LVDS)*
J24	PR24B	2	RDQ21	C
J26	PR24A	2	RDQ21	T
GND	GNDIO2	-		
K29	PR23B	2	RDQ21	C (LVDS)*
K30	PR23A	2	RDQ21	T (LVDS)*
J23	PR22B	2	RDQ21	C
J25	PR22A	2	RDQ21	T
VCCIO	VCCIO2	99		
J27	PR21B	2	RDQ21	C (LVDS)*
J28	PR21A	2	RDQS21	T (LVDS)*
H26	PR20B	2	RDQ21	C
GND	GNDIO2	-		
H24	PR20A	2	RDQ21	T
J29	PR19B	2	RDQ21	C (LVDS)*
J30	PR19A	2	RDQ21	T (LVDS)*
H25	PR18B	2	RDQ21	C
VCCIO	VCCIO2	2		
H23	PR18A	2	RDQ21	T
G27	PR15B	2	RUM1_SPLLC_FB_A/RDQ12	C
GND	GNDIO2	-		
H27	PR15A	2	RUM1_SPLLT_FB_A/RDQ12	T
G29	PR14B	2	RUM1_SPLLC_IN_A/RDQ12	C (LVDS)*
G28	PR14A	2	RUM1_SPLLT_IN_A/RDQ12	T (LVDS)*
VCCIO	VCCIO2	2		
GND	GNDIO2	-		
G26	PR6B	2		C (LVDS)*
G25	PR6A	2		T (LVDS)*
G30	PR5B	2		C
F30	PR5A	2		T
VCCIO	VCCIO2	2		
F26	PR4B	2		C (LVDS)*
F27	PR4A	2		T (LVDS)*
F29	PR3B	2		C
GND	GNDIO2	-		
F28	PR3A	2		T
H29	PR2B	2	VREF2_2	C (LVDS)*
H30	PR2A	2	VREF1_2	T (LVDS)*
VCCIO	VCCIO2	2		
B26	PT100B	1	VREF2_1	C
A26	PT100A	1	VREF1_1	T
GND	GNDIO1	-		
C25	PT99B	1		C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO7	-			GNDIO7	-			
K5	PL23A	7	LDQS23	T (LVDS)*	PL27A	7	LDQS27	T*	
L5	PL23B	7	LDQ23	C (LVDS)*	PL27B	7	LDQ27	C*	
K4	PL24A	7	LDQ23	T	PL28A	7	LDQ27	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L4	PL24B	7	LDQ23	C	PL28B	7	LDQ27	C	
K3	PL25A	7	LDQ23	T (LVDS)*	PL29A	7	LDQ27	T*	
L3	PL25B	7	LDQ23	C (LVDS)*	PL29B	7	LDQ27	C*	
J1	PL26A	7	LDQ23	T	PL30A	7	LDQ27	T	
GNDIO	GNDIO7	-			GNDIO7	-			
K2	PL26B	7	LDQ23	C	PL30B	7	LDQ27	C	
K1	PL28A	7	LUM1_SPLLT_IN_A/LDQ32	T (LVDS)*	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T*	
L1	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C*	
K8	PL29A	7	LUM1_SPLLT_FB_A/LDQ32	T	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	
M5	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	
VCCIO	VCCIO7	7			VCCIO7	7			
M4	PL30A	7	LDQ32	T (LVDS)*	PL34A	7	LDQ36	T*	
M3	PL30B	7	LDQ32	C (LVDS)*	PL34B	7	LDQ36	C*	
L8	PL31A	7	LDQ32	T	PL35A	7	LDQ36	T	
M6	PL31B	7	LDQ32	C	PL35B	7	LDQ36	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL32A	7	LDQS32	T (LVDS)*	PL36A	7	LDQS36	T*	
N1	PL32B	7	LDQ32	C (LVDS)*	PL36B	7	LDQ36	C*	
N3	PL33A	7	LDQ32	T	PL37A	7	LDQ36	T	
VCCIO	VCCIO7	7			VCCIO7	7			
N2	PL33B	7	LDQ32	C	PL37B	7	LDQ36	C	
N5	PL34A	7	LDQ32	T (LVDS)*	PL38A	7	LDQ36	T*	
N4	PL34B	7	LDQ32	C (LVDS)*	PL38B	7	LDQ36	C*	
M7	PL35A	7	PCLKT7_0/LDQ32	T	PL39A	7	PCLKT7_0/LDQ36	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M8	PL35B	7	PCLKC7_0/LDQ32	C	PL39B	7	PCLKC7_0/LDQ36	C	
P3	PL37A	6	PCLKT6_0	T (LVDS)*	PL41A	6	PCLKT6_0	T*	
P2	PL37B	6	PCLKC6_0	C (LVDS)*	PL41B	6	PCLKC6_0	C*	
P5	PL38A	6	VREF2_6	T	PL42A	6	VREF2_6	T	
N6	PL38B	6	VREF1_6	C	PL42B	6	VREF1_6	C	
P4	PL39A	6		T (LVDS)*	PL43A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
R3	PL39B	6		C (LVDS)*	PL43B	6		C*	
P6	PL40A	6		T	PL44A	6		T	
N7	NC	-			PL44B	6		C	
P1	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	PL45A	6	LLM3_SPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
R1	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	PL45B	6	LLM3_SPLLC_IN_A	C*	
N8	PL42A	6	LLM2_SPLLT_FB_A	T	PL46A	6	LLM3_SPLLT_FB_A	T	
R5	PL42B	6	LLM2_SPLLC_FB_A	C	PL46B	6	LLM3_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL44A	6	LDQ48	T (LVDS)*	PL48A	6	LDQ52	T*	
T4	PL44B	6	LDQ48	C (LVDS)*	PL48B	6	LDQ52	C*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AC15	PB27B	5	BDQ24	C	PB42B	5	BDQ42	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AD15	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T	
AF15	PB38B	5	BDQ42	C	PB47B	5	BDQ51	C	
AG10	PB39A	5	BDQ42	T	PB48A	5	BDQ51	T	
AG9	PB39B	5	BDQ42	C	PB48B	5	BDQ51	C	
AH14	PB40A	5	BDQ42	T	PB49A	5	BDQ51	T	
AG12	PB40B	5	BDQ42	C	PB49B	5	BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AG15	PB41A	5	BDQ42	T	PB50A	5	BDQ51	T	
AG13	PB41B	5	BDQ42	C	PB50B	5	BDQ51	C	
GNDIO	GNDIO5	-			GNDIO5	-			
AF16	PB42A	5	BDQS42	T	PB51A	5	BDQS51	T	
AH15	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C	
AC16	PB43A	5	VREF2_5/BDQ42	T	PB52A	5	VREF2_5/BDQ51	T	
AE16	PB43B	5	VREF1_5/BDQ42	C	PB52B	5	VREF1_5/BDQ51	C	
AG11	PB44A	5	PCLKT5_0/BDQ42	T	PB53A	5	PCLKT5_0/BDQ51	T	
AF11	PB44B	5	PCLKC5_0/BDQ42	C	PB53B	5	PCLKC5_0/BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AJ14	PB49A	4	PCLKT4_0/BDQ51	T	PB58A	4	PCLKT4_0/BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AK14	PB49B	4	PCLKC4_0/BDQ51	C	PB58B	4	PCLKC4_0/BDQ60	C	
AK15	PB50A	4	VREF2_4/BDQ51	T	PB59A	4	VREF2_4/BDQ60	T	
AK16	PB50B	4	VREF1_4/BDQ51	C	PB59B	4	VREF1_4/BDQ60	C	
AF18	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T	
GNDIO	GNDIO4	-			GNDIO4	-			
AD16	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C	
AJ15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AG16	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AE17	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AC17	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C	
AH16	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AK17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
AG20	PB55A	4	BDQ51	T	PB64A	4	BDQ60	T	
GNDIO	GNDIO4	-			GNDIO4	-			
AG21	PB55B	4	BDQ51	C	PB64B	4	BDQ60	C	
AG18	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T	
AJ16	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C	
AF21	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T	
AG22	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C	
AD17	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T	
AF19	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
AH17	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ30	LRC_SQ_VCCIB0	13		
AK29	LRC_SQ_HDINP0	13		T
AH30	LRC_SQ_VCCRX0	13		
AG27	CFG2	8		
AD25	CFG1	8		
AG28	CFG0	8		
AG30	PROGRAMN	8		
AG29	CCLK	8		
AC24	INITN	8		
AF27	DONE	8		
GNDIO	GNDIO8	-		
AF28	WRITEN***	8		
AE26	CS1N***	8		
AB23	CSN***	8		
AF29	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
AF30	D1***	8		
AD26	D2***	8		
AE29	D3***	8		
GNDIO	GNDIO8	-		
AE30	D4***	8		
AD29	D5***	8		
AC25	D6***	8		
AD30	D7/SPID0***	8		
VCCIO	VCCIO8	8		
AA22	DI/CSSPI0N***	8		
AC26	DOUT/CSON/CSSPI1N***	8		
AA23	BUSY/SISPI***	8		
AB22	RLM0_PLLCAP	3		
AC27	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-		
AC28	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AC29	PR101B	3	RLM0_GDLLC_IN_A**/RDQ99	C (LVDS)*
AC30	PR101A	3	RLM0_GDLLT_IN_A**/RDQ99	T (LVDS)*
AB30	PR100B	3	RLM0_GPLLC_IN_A**/RDQ99	C
VCCIO	VCCIO3	3		
AA30	PR100A	3	RLM0_GPLLT_IN_A**/RDQ99	T
AB29	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AB28	PR99A	3	RLM0_GPLLT_FB_A/RDQS99	T (LVDS)*
GNDIO	GNDIO3	-		
Y22	PR98B	3	RDQ99	C
Y23	PR98A	3	RDQ99	T
AB26	PR97B	3	RDQ99	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO3	3		
T22	PR69A	3	RDQ72	T
T29	PR68B	3	RDQ72	C (LVDS)*
T28	PR68A	3	RDQ72	T (LVDS)*
R23	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-		
-	-	-		
R22	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
P30	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
R29	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
T27	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
T26	PR64A	3	RDQ63	T
GNDIO	GNDIO3	-		
N30	PR61B	3	RDQ63	C (LVDS)*
N29	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
R27	PR60B	3	VREF2_3/RDQ63	C
R28	PR60A	3	VREF1_3/RDQ63	T
P29	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
P28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
M30	PR57B	2	PCLKC2_0/RDQ54	C
M29	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-		
P23	PR56B	2	RDQ54	C (LVDS)*
P24	PR56A	2	RDQ54	T (LVDS)*
R26	PR55B	2	RDQ54	C
P27	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
P25	PR54B	2	RDQ54	C (LVDS)*
P26	PR54A	2	RDQS54	T (LVDS)*
K30	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-		
K29	PR53A	2	RDQ54	T
N22	PR52B	2	RDQ54	C (LVDS)*
P22	PR52A	2	RDQ54	T (LVDS)*
J30	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2		
J29	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
N24	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
N23	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
N25	PR48B	2	RDQ45	C
N26	PR48A	2	RDQ45	T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
H14	PT61A	0		T
A14	PT60B	0		C
B14	PT60A	0		T
D13	PT59B	0		C
GNDIO	GNDIO0	-		
F13	PT59A	0		T
G13	PT58B	0		C
VCCIO	VCCIO0	0		
J11	PT58A	0		T
D4	PT57B	0		
D5	PT56A	0		
E5	PT55B	0		C
F6	PT55A	0		T
GNDIO	GNDIO0	-		
VCCIO	VCCIO0	0		
F7	PT52B	0		C
D8	PT52A	0		T
GNDIO	GNDIO0	-		
J13	PT50B	0		C
G11	PT50A	0		T
H13	PT49B	0		C
H12	PT49A	0		T
VCCIO	VCCIO0	0		
E8	PT48B	0		C
D9	PT48A	0		T
D12	PT46B	0		C
GNDIO	GNDIO0	-		
E13	PT46A	0		T
VCCIO	VCCIO0	0		
GNDIO	GNDIO0	-		
J12	PT31B	0		C
-	-	-		
VCCIO	VCCIO0	0		
H10	PT31A	0		T
E12	PT30B	0		C
D11	PT30A	0		T
H11	PT29B	0		C
F11	PT29A	0		T
C13	ULC_SQ_VCCR0	11		
A12	ULC_SQ_HDINP0	11		T
B13	ULC_SQ_VCCIB0	11		
B12	ULC_SQ_HDINN0	11		C
C10	ULC_SQ_VCCTX0	11		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U22	GND	-			GND	-		
U23	GND	-			GND	-		
V12	GND	-			GND	-		
V13	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V18	GND	-			GND	-		
V19	GND	-			GND	-		
V20	GND	-			GND	-		
V22	GND	-			GND	-		
V23	GND	-			GND	-		
W12	GND	-			GND	-		
W13	GND	-			GND	-		
W15	GND	-			GND	-		
W16	GND	-			GND	-		
W17	GND	-			GND	-		
W18	GND	-			GND	-		
W19	GND	-			GND	-		
W20	GND	-			GND	-		
W22	GND	-			GND	-		
W23	GND	-			GND	-		
W26	GND	-			GND	-		
W31	GND	-			GND	-		
W4	GND	-			GND	-		
W9	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
Y18	GND	-			GND	-		
Y19	GND	-			GND	-		
A11	NC	-			NC	-		
A12	NC	-			NC	-		
A23	NC	-			NC	-		
A24	NC	-			NC	-		
AA11	NC	-			NC	-		
AB11	NC	-			NC	-		
AC26	NC	-			NC	-		
AC30	NC	-			NC	-		
AD11	NC	-			NC	-		
AD12	NC	-			NC	-		
AD13	NC	-			NC	-		
AD14	NC	-			NC	-		
AD15	NC	-			NC	-		
AD19	NC	-			NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD23	NC	-			NC	-		
AE10	NC	-			NC	-		
AE11	NC	-			NC	-		

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20